

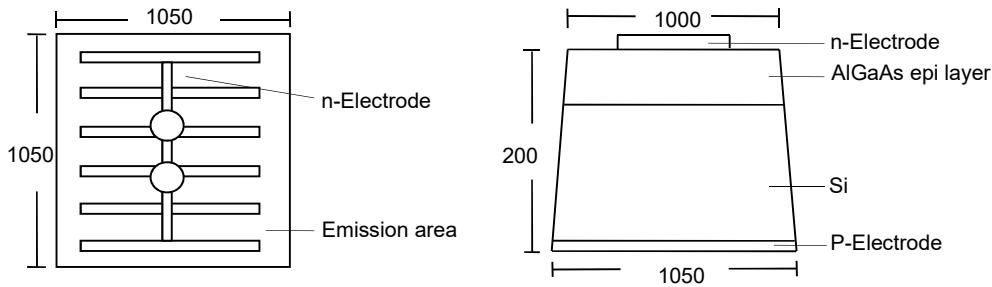
■ **Features :**

- Suitable for New Creative Products
- High Power
- High Performance
- Superior Thermal Stability

■ **Typical Applications :**

- Night Vision
- Camera
- Outdoor/Indoor applications

■ **Outline Dimensions : (Unit: um)**



■ **Physical Structure :**

LED Chip dimension	Chip size	1050 um x 1050 um
	Thickness	200 ± 25 um
	Emission area	1000 um
	Bonding pad	130±10 um
Electrode	Top: N (cathode)	Gold
	Backside: P (anode)	Gold

*C2

■ **Electro-Optical Characteristics : (Ta = 25°C)**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V_{FH}	$I_F = 350 \text{ mA}$	1.70	-	1.90	V
Reverse Current	I_R	$V_R = 5 \text{ V}$	-	-	1	μA
Radiant Power	P_o	$I_F = 350 \text{ mA}$	75	-	120	mW
Wavelength	λ_P	$I_F = 350 \text{ mA}$	750	-	790	nm
Spectral width at half height	$\Delta \lambda$	$I_F = 350 \text{ mA}$	-	20	-	nm